

Ab initio characterization of defect states in materials for next-generation technology

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Motivations & State-of-the-art

- Incoming limitations of Si-technology & drive for improving application range of materials
- **New** complex non-Si-based **materials** (chalcogenides, metal-oxides, ferroelectrics, etc.)
- **Highly defective**, disordered and **amorphous** [1] with complex physical effects (electrical switching, quantum confinement, topology, spin, etc.)
- Material characteristics (interplay) Devices performances (complex architectures, device reliability, etc.)
- Characterization/identification/control of defect states: crucial to characterize properties of emerging materials, hence for design/optimization of next-generation electronic devices



Ge vacancy

Crucial also for understanding properties of already known materials at the atomic level [2] to and reveal the connections between **atomic** and **electronic** structures



[1] M.-J. Lee, et al., Nat. Commun. 4, 2629 (2013); F. Tavanti et al., ACS Appl. Electron. Mater. 2, 2961 (2020) [2] P. Mazzolini, et al., Adv. Electron. Mater. 2, 1500316 (2016); J. Osorio-Guillén et al., Phys. Rev. Lett. 100, 036601 (2008); J. Nowotny, et al., Chem. Soc. Rev., 44, 8424 (2015); M. Gerosa, et al., Nat. Mater. 17, 1122 (2018)



KPMG Global Semiconductor Survey 2017

- Image charge interaction;
- Spurious interactions;

• Potential alignment;

Electrostatic Gaussian counter-charge scheme

 $\mathbf{O} \mathbf{E}_{corr} = q \Delta V_{corr}$ contains several contributions:

 $\mu_i \rightarrow$ DFT calculations + thermodynamic considerations

P. Giannozzi et al., J. Phys.: Condens. Matter 21, 395502 (2009 & 2017) C. Freysoldt, et al., Phys. Rev. Lett. 102, 016402 (2009) C. Freysoldt, et al., Rev. Mod. Phys. 86, 253 (2014) J. Buckeridge, et al., Comput. Phys. Commun. 185, 330 (2014) J. Buckeridge, Comput. Phys. Commun. 244, 329 (2019) H.-P. Komsa, et al., Phys. Rev. Lett. **110**, 095505 (2013) G. Pizzi, et al., Comp. Mat. Sci. **111**, 218 (2016) I. Dabo, et al., Phys. Rev. B 77, 115139 (2008) http://www.aiida.net





Towards full automation of defect calculations

Point defects in crystalline GeSe

Point defects in anatase TiO₂

Methods

Bulk electronic structure of GeSe



✓ Crystalline and amorphous chalcogenides promising for applications spanning from photoelectrocatalysis to memory devices and selectors for next generation electronics [1]

✓ **GeSe**: Energy gap, $Eg \approx 1.1 \text{ eV}$, Fermi level (E_F) indicated ✓ Orthorhombic cell

✓ **Supercells** used for defect simulations

- 3x2x1 (48 atoms)
- 4x4x2 (256 atoms)
- 5x4x2 (320 atoms)





Defect formation energies as a function of **supercell size**: **convergence** is reached

When a **Ge** vacancy is created, the density of states (DOS) shows a partially occupied state in the energy gap



Electronic structure of anatase TiO₂: host and selected defective structures



O interstitial, O_i

- \checkmark **TiO**₂ well-known material with a wide range of applications spanning form photocatalysis to memory devices and transparent conductivity (TC)
- \checkmark Relatively less studied Ta-doped TiO₂ (TaTO) promising mobility and dopant solubility for TC [2]. Here we focus on O-rich condition
- ✓ TiO₂: Eg ≈ 3.3 eV, E_F indicated
- ✓ Defects introduce deep states in the gap
- ✓ **Supercell** used for defect simulations: 2x2x2 (96 atoms)

Database for Computational Science





